#### **DESCRIPTION**

The SPN3458 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

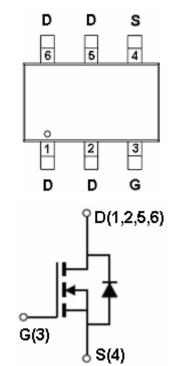
#### **FEATURES**

- 60V/5.0A, RDS(ON)=  $115\Omega$ @VGS=10V
- 60V/4.5A, RDS(ON)=  $125\Omega$ @VGS=4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ TSOP-6P package design

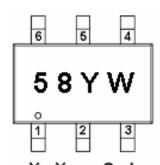
#### **APPLICATIONS**

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

### PIN CONFIGURATION (TSOP-6P)



### PART MARKING



Y: Year Code W: Week Code

# **PIN DESCRIPTION**

Pin	Symbol	Description
1	D	Drain
2	D	Drain
3	G	Gate
4	S	Source
5	D	Drain
6	D	Drain

# **ORDERING INFORMATION**

Part Number	Package	Part Marking
SPN3458ST6RGB	TSOP-6P	58YW

**%** Week Code :  $A \sim Z(1 \sim 26)$ ;  $a \sim z(27 \sim 52)$ 

※ SPN3458ST6RG: Tape Reel; Pb − Free; Halogen − Free

### **ABSOULTE MAXIMUM RATINGS**

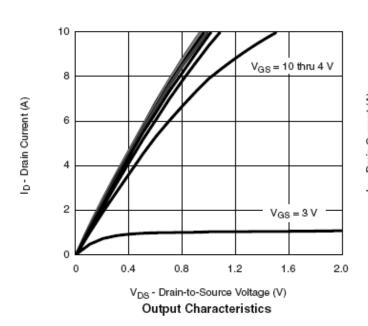
(T<sub>A</sub>=25°C Unless otherwise noted)

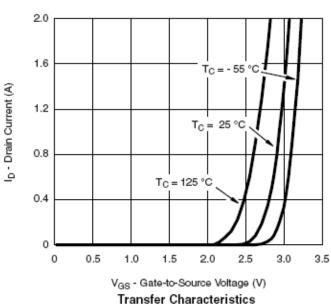
Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	Vdss	60	V	
Gate –Source Voltage	VGSS	±20	V	
Continuous Drain Current(Tr-150°C)	TA=25°C	In	5.0	Α.
Continuous Drain Current(TJ=150°€)	TA=70°C	- Id	4.0	A
Pulsed Drain Current	Ірм	10	A	
Continuous Source Current(Diode Conduct	Is	2.0	A	
Down Dissinction	TA=25°C	Drs	2.0	W
Power Dissipation	TA=70°C	PD	1.3	W
Operating Junction Temperature	TJ	150	$^{\circ}\mathbb{C}$	
Storage Temperature Range	Tstg	-55/150	$^{\circ}\!\mathbb{C}$	
Thermal Resistance-Junction to Ambient	RθJA	90	°C/W	

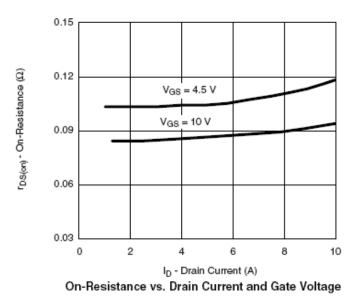
# **ELECTRICAL CHARACTERISTICS**

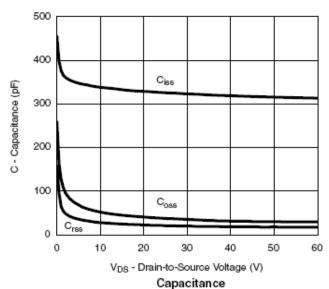
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V(BR)DSS	V <sub>G</sub> S=0V,I <sub>D</sub> =250uA	60			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.5		1.5	]	
Gate Leakage Current	Igss	V <sub>DS</sub> =0V,V <sub>GS</sub> =±20V			±100	nA	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =60V,V <sub>GS</sub> =0.0V V <sub>DS</sub> =60V,V <sub>GS</sub> =0.0V T <sub>J</sub> =55°C			1 10	uA	
On-State Drain Current	ID(on)	V <sub>D</sub> s ≥ 4.5 V, V <sub>G</sub> s=4.5 V	10			Α	
Drain-Source On-Resistance	RDS(on)	V <sub>GS</sub> = 10V,I <sub>D</sub> =5.0A V <sub>GS</sub> =4.5V,I <sub>D</sub> =4.5A		0.106 0.118	0.115 0.125	Ω	
Forward Transconductance	gfs	V <sub>DS</sub> =15V,I <sub>D</sub> =4.0A		12		S	
Diode Forward Voltage	Vsd	Is=2.5A,VGS=0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Qg			4.0	6		
Gate-Source Charge	Qgs	V <sub>DS</sub> =30V, V <sub>GS</sub> =4.5V I <sub>D</sub> =4.0A		1.2		nC	
Gate-Drain Charge	Qgd	-1D-4.0/ <b>1</b>		1.0			
Input Capacitance	Ciss			320		pF	
Output Capacitance	Coss	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V f=1MHz		42			
Reverse Transfer Capacitance	Crss			20		<b> </b>	
T On Time	td(on)			6	10	ns	
Turn-On Time	tr	$V_{DD}=30V$ , $R_{L}=12\Omega$		12	20		
Turn Off Time	td(off)	ID=2.5A,VGEN=10V RG=6 $\Omega$		18	30		
Turn-Off Time	tf			10	15	] <b> </b>	









0

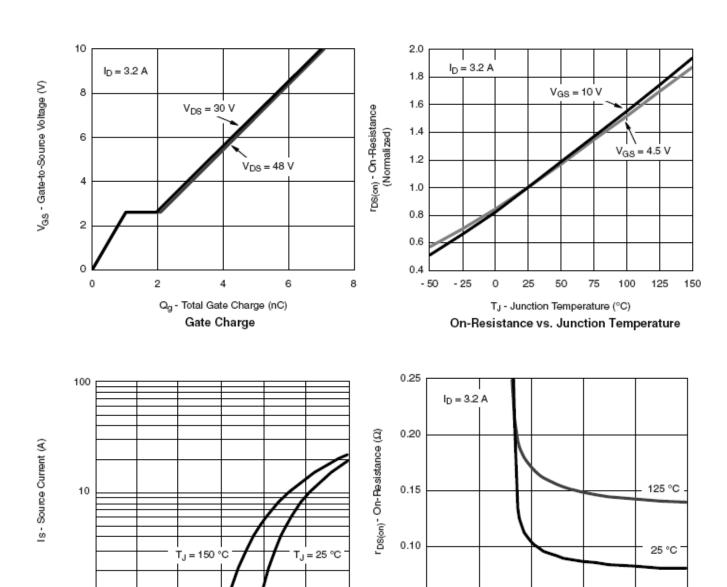
0.2

0.6

V<sub>SD</sub> - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

0.8



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1.2

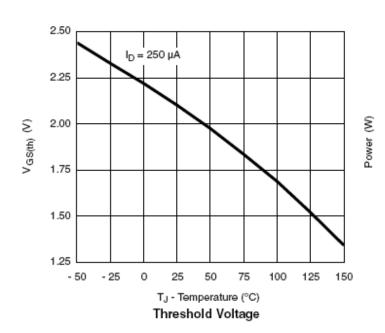
0.05

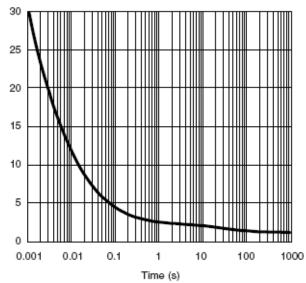
0

V<sub>GS</sub> - Gate-to-Source Voltage (V)

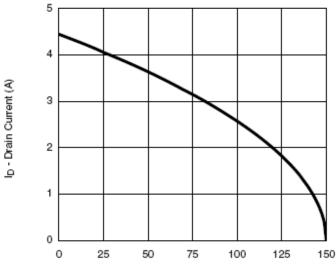
On-Resistance vs. Gate-to-Source Voltage

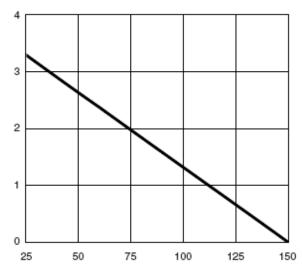
10





Single Pulse Power (Junction-to-Ambient)

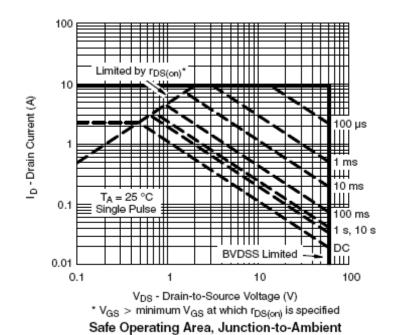


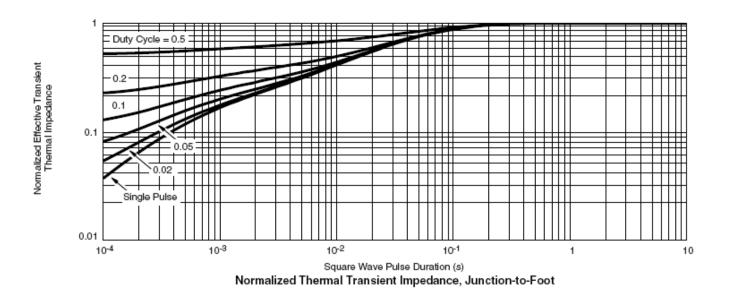


T<sub>C</sub> - Foot (Drain) Temperature (°C) T<sub>C</sub> - Foot (Drain) Temperature (°C)

Current Derating\* Power Derating

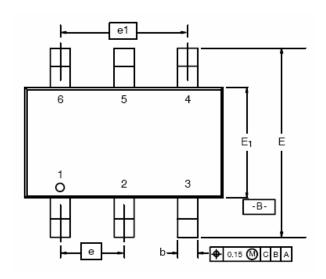
Power Dissipation (W)

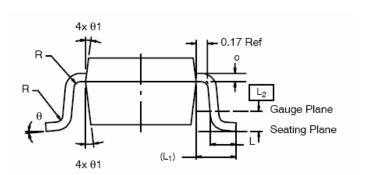






# TSOP- 6P PACKAGE OUTLINE





	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.91	-	1.10	0.036	-	0.043
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.108	0.112	0.117
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067
е	1.00 BSC			0.0394 BSC		
e <sub>1</sub>	1.90	2.00	2.10	0.075	0.080	0.085
Г	0.35	-	0.50	0.014	-	0.020
L <sub>1</sub>	0.60 Ref				0.024 Ref	
L <sub>2</sub>	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4*	8°	0"	4*	8"
θ1	7° Nom			7° Nom		

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